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SN74AVC16T245 16-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

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FEATURES

- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I_{off} Supports Partial-Power-Down Mode Operation
- I/Os Are 4.6-V Tolerant
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ORDERING INFORMATION

This 16-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVC16T245 is optimized to operate with $V_{\rm CCA}/V_{\rm CCB}$ set at 1.4 V to 3.6 V. It is operational with $V_{\rm CCA}/V_{\rm CCB}$ as low as 1.2 V. The A port is designed to track $V_{\rm CCA}$. $V_{\rm CCA}$ accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track $V_{\rm CCB}$. $V_{\rm CCB}$ accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

DGG OR DGV PACKAGE (TOP VIEW)

| | | $\overline{}$ | ì |
|--------------------|----|---------------|-------------|
| 1DIR | 1 | ر 48 | 1 <u>0E</u> |
| 1B1 [| 2 | 47 |] 1A1 |
| 1B2 [| 3 | 46 |] 1A2 |
| GND [| 4 | 45 | GND |
| 1B3 [| 5 | 44 |] 1A3 |
| 1B4 [| 6 | 43 |] 1A4 |
| √ _{ССВ} [| 7 | 42 | VCCA |
| 1B5 [| 8 | 41 |] 1A5 |
| 1B6 [| 9 | 40 |] 1A6 |
| GND [| 10 | 39 | GND |
| 1B7 [| 11 | 38 |] 1A7 |
| 1B8 [| 12 | 37 |] 1A8 |
| 2B1 [| 13 | 36 |] 2A1 |
| 2B2 [| 14 | 35 |] 2A2 |
| GND [| 15 | 34 | GND |
| 2B3 [| 16 | 33 |] 2A3 |
| 2B4 [| 17 | 32 |] 2A4 |
| √ссв[| 18 | 31 | VCCA |
| 2B5 [| 19 | 30 |] 2A5 |
| 2B6 [| 20 | 29 |] 2A6 |
| GND [| 21 | 28 | GND |
| 2B7 [| 22 | 27 |] 2A7 |
| 2B8 [| 23 | 26 | 2A8 |
| 2DIR [| 24 | 25 | 2 <u>0E</u> |
| | | | |

The SN74AVC16T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so the buses effectively are isolated.

The SN74AVC16T245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V_{CCA}.

ORDERING INFORMATION

| T _A | PACKAGE | (1) | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|----------------|-----------------------|---------------|-----------------------|------------------|--|
| | TSSOP - DGG | Tape and reel | SN74AVC16T245DGGR | AVC16T245 | |
| –40°C to 85°C | TVSOP – DGV | Tape and reel | SN74AVC16T245DGVR | WF245 | |
| -40°C 10 85°C | VFBGA – GQL | Tone and real | SN74AVC16T245GQLR | WED4E | |
| | VFBGA – ZQL (Pb-free) | Tape and reel | SN74AVC16T245ZQLR | WF245 | |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS WWW.ti.com

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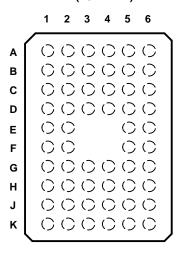
DESCRIPTION/ORDERING INFORMATION (CONTINUED)

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

GQL OR ZQL PACKAGE (TOP VIEW)



TERMINAL ASSIGNMENTS(2)

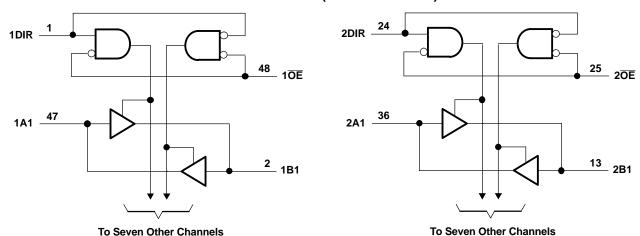
| | 1 | 2 | 3 | 4 | 5 | 6 |
|---|------|-----|------------------|------------------|-----|-----------------|
| Α | 1DIR | NC | NC | NC | NC | 1 OE |
| В | 1B2 | 1B1 | GND | GND | 1A1 | 1A2 |
| С | 1B4 | 1B3 | V _{CCB} | V _{CCA} | 1A3 | 1A4 |
| D | 1B6 | 1B5 | GND | GND | 1A5 | 1A6 |
| E | 1B8 | 1B7 | | | 1A7 | 1A8 |
| F | 2B1 | 2B2 | | | 2A2 | 2A1 |
| G | 2B3 | 2B4 | GND | GND | 2A4 | 2A3 |
| Н | 2B5 | 2B6 | V _{CCB} | V _{CCA} | 2A6 | 2A5 |
| J | 2B7 | 2B8 | GND | GND | 2A8 | 2A7 |
| K | 2DIR | NC | NC | NC | NC | 2 OE |

⁽²⁾ NC - No internal connection

FUNCTION TABLE (EACH 8-BIT SECTION)

| INP | UTS | OPERATION |
|-----|-----|-----------------|
| OE | DIR | OPERATION |
| L | L | B data to A bus |
| L | Н | A data to B bus |
| Н | Χ | Isolation |

LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|-------------------|--|--------------------|------|------------------------|------|
| $V_{CCA} V_{CCB}$ | Supply voltage range | | -0.5 | 4.6 | V |
| | | I/O ports (A port) | -0.5 | 4.6 | |
| V_{I} | Input voltage range (2) | I/O ports (B port) | -0.5 | 4.6 | V |
| | | Control inputs | -0.5 | 4.6 | |
| \/ | Voltage range applied to any output | A port | -0.5 | 4.6 | V |
| Vo | n the high-impedance or power-off state (2) Voltage range applied to any output in the high or low state (2)(3) | B port | -0.5 | 4.6 | V |
| \/ | Voltage range applied to any output in the high or law state (2)(3) | A port | -0.5 | $V_{CCA} + 0.5$ | V |
| Vo | voltage range applied to any output in the high of low state (-) (-) | B port | -0.5 | V _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| Io | Continuous output current | · | | ±50 | mA |
| | Continuous current through each V _{CCA} , V _{CCB} , and GND | | | ±100 | mA |
| | | DGG package | | 70 | |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | DGV package | | 58 | °C/W |
| | | GQL/ZQL package | | 42 | |
| T _{stg} | Storage temperature range | · | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



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Recommended Operating Conditions (1)(2)(3)

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------|------------------------------|--|------------------|------------------|-------------------------|-----------------------|------|
| V _{CCA} | Supply voltage | | | | 1.2 | 3.6 | V |
| V _{CCB} | Supply voltage | | | | 1.2 | 3.6 | V |
| | | | 1.2 V to 1.95 V | | V _{CCI} × 0.65 | | |
| V_{IH} | High-level input voltage | Data inputs ⁽⁴⁾ | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltage | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.2 V to 1.95 V | | | $V_{CCI} \times 0.35$ | |
| V_{IL} | Low-level input voltage | Data inputs ⁽⁴⁾ | 1.95 V to 2.7 V | | | 0.7 | V |
| | input voltage | | 2.7 V to 3.6 V | | | 0.8 | |
| | | | 1.2 V to 1.95 V | | $V_{CCA} \times 0.65$ | | |
| V_{IH} | High-level input voltage | DIR (referenced to V _{CCA}) ⁽⁵⁾ | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltage | (referenced to ACCV) | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.2 V to 1.95 V | | | $V_{CCA} \times 0.35$ | |
| V_{IL} | Low-level input voltage | DIR (referenced to V _{CCA}) ⁽⁵⁾ | 1.95 V to 2.7 V | | | 0.7 | V |
| | | (referenced to ACCV) | 2.7 V to 3.6 V | | | 0.8 | |
| V _I | Input voltage | <u> </u> | | | 0 | 3.6 | V |
| 17 | Outrut valtage | Active state | | | 0 | V _{cco} | 1/ |
| V_{O} | Output voltage | 3-state | | | 0 | 3.6 | V |
| | | <u> </u> | | 1.2 V | | -3 | |
| | | | | 1.4 V to 1.6 V | | -6 | |
| I_{OH} | High-level output curr | ent | | 1.65 V to 1.95 V | | -8 | mA |
| | | | | 2.3 V to 2.7 V | | -9 | |
| | | | | 3 V to 3.6 V | | -12 | |
| | | | | 1.2 V | | 3 | |
| | | | | 1.4 V to 1.6 V | | 6 | |
| I_{OL} | Low-level output curre | ent | | 1.65 V to 1.95 V | | 8 | mA |
| | JL 2011 10101 001pdt 0011011 | | | 2.3 V to 2.7 V | | 9 | |
| | | | | 3 V to 3.6 V | | 12 | |
| Δt/Δν | Input transition rise or | fall rate | | | | 5 | ns/V |
| T _A | Operating free-air ten | perature | | | -40 | 85 | °C |

⁽¹⁾ V_{CCI} is the V_{CC} associated with the data input port.
(2) V_{CCO} is the V_{CC} associated with the output port.
(3) All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
(4) For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V.
(5) For V_{CCA} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.

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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

| DAD | AMETER | TEST COND | TIONS | V | V | T, | _A = 25°C | | –40°C to 8 | 5°C | UNIT |
|-------------------|------------------|---|----------------|------------------|------------------|-----|---------------------|-------|------------------------|------------|------|
| FARA | AIVIETER | TEST CONDI | TIONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | MIN | MAX | UNIT |
| | | $I_{OH} = -100 \mu A$ | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | V _{CCO} - 0.2 | | |
| | | $I_{OH} = -3 \text{ mA}$ | | 1.2 V | 1.2 V | | 0.95 | | | | |
| ., | | $I_{OH} = -6 \text{ mA}$ | $V_I = V_{IH}$ | 1.4 V | 1.4 V | | | | 1.05 | | V |
| V _{OH} | | $I_{OH} = -8 \text{ mA}$ | $v_I = v_{IH}$ | 1.65 V | 1.65 V | | | | 1.2 | | V |
| | | $I_{OH} = -9 \text{ mA}$ | | 2.3 V | 2.3 V | | | | 1.75 | | |
| | | $I_{OH} = -12 \text{ mA}$ | | 3 V | 3 V | | | | 2.3 | | |
| | | I_{OL} = 100 μ A | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 0.2 | |
| | | $I_{OL} = 3 \text{ mA}$ | | 1.2 V | 1.2 V | | 0.15 | | | | |
| V _{OL} | | $I_{OL} = 6 \text{ mA}$ | $V_I = V_{IL}$ | 1.4 V | 1.4 V | | | | | 0.35 | V |
| OL | | $I_{OL} = 8 \text{ mA}$ | VI = VIL | 1.65 V | 1.65 V | | | | | 0.45 | V |
| | | $I_{OL} = 9 \text{ mA}$ | | 2.3 V | 2.3 V | | | | | 0.55 | |
| | | I _{OL} = 12 mA | | 3 V | 3 V | | | | | 0.7 | |
| I | Control inputs | $V_I = V_{CCA}$ or GN | D | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | ±0.025 | ±0.25 | | ±1 | μΑ |
| | A or B port | V V 0.12 0.0 V | | 0 V | 0 to 3.6 V | | ±0.1 | ±2.5 | | ±5 | A |
| off | A or B port | V_1 or $V_0 = 0$ to 3 | 0.0 V | 0 to 3.6 V | 0 V | | ±0.5 | ±2.5 | | ±5 | μА |
| oz ⁽³⁾ | A or B port | $V_O = V_{CCO}$ or G $V_I = V_{CCI}$ or GN $\overline{OE} = V_{IH}$ | ND, D, | 3.6 V | 3.6 V | | ±0.5 | ±2.5 | | ±5 | μΑ |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 25 | |
| CCA | | $V_I = V_{CCI}$ or GN $I_O = 0$ | D, | 0 V | 3.6 V | | | | | -5 | μΑ |
| | | 10 = 0 | | 3.6 V | 0 V | | | | | 25 | |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 25 | |
| ССВ | | $V_I = V_{CCI}$ or GN $I_C = 0$ | D, | 0 V | 3.6 V | | | | | 25 | μΑ |
| | | 10 = 0 | | 3.6 V | 0 V | | | | | - 5 | |
| CCA + | I _{CCB} | $V_I = V_{CCI}$ or GN $I_O = 0$ | D, | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 45 | μΑ |
| C _i | Control inputs | V _I = 3.3 V or GN | ND | 3.3 V | 3.3 V | | 3.5 | | | | pF |
| C _{io} | A or B | V _O = 3.3 V or G | ND | 3.3 V | 3.3 V | | 7 | | | | pF |

 ⁽¹⁾ V_{CCO} is the V_{CC} associated with the output port.
 (2) V_{CCI} is the V_{CC} associated with the input port.
 (3) For I/O ports, the parameter I_{OZ} includes the input leakage current.



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Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (see Figure 11)

| PARAMETER | FROM | то | V _{CCB} = 1.2 V | V _{CCB} = 1.5 V | V _{CCB} = 1.8 V | V _{CCB} = 2.5 V | V _{CCB} = 3.3 V | UNIT |
|------------------|---------|----------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|------|
| FARAIVIETER | (INPUT) | (OUTPUT) | TYP | TYP | TYP | TYP | TYP | UNIT |
| t _{PLH} | А | В | 4.1 | 3.3 | 3 | 2.8 | 3.2 | no |
| t _{PHL} | A | Ь | 4.1 | 3.3 | 3 | 2.8 | 3.2 | ns |
| t _{PLH} | В | Α | 4.4 | 4 | 3.8 | 3.6 | 3.5 | 20 |
| t _{PHL} | Ь | A | 4.4 | 4 | 3.8 | 3.6 | 3.5 | ns |
| t _{PZH} | ŌĒ | Α | 6.4 | 6.4 | 6.4 | 6.4 | 6.4 | ns |
| t _{PZL} | OE | A | 6.4 | 6.4 | 6.4 | 6.4 | 6.4 | 115 |
| t _{PZH} | ŌĒ | В | 6 | 4.6 | 4 | 3.4 | 3.2 | 20 |
| t _{PZL} | OL | В | 6 | 4.6 | 4 | 3.4 | 3.2 | ns |
| t _{PHZ} | ŌĒ | Α | 6.6 | 6.6 | 6.6 | 6.6 | 6.8 | ns |
| t _{PLZ} | OE | A | 6.6 | 6.6 | 6.6 | 6.6 | 6.8 | 115 |
| t _{PHZ} | ŌĒ | ŌĒ B | 6 | 4.9 | 4.9 | 4.2 | 5.3 | nc |
| t _{PLZ} | OE | Б | 6 | 4.9 | 4.9 | 4.2 | 5.3 | ns |

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 11)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT | | | | | | | | | | | | | | | | | | | | | | |
|------------------|-----------------|----------------|--------------------------|-----------------------------|------|-----------------------------|------|--------------------------|------|--------------------------|------|------|-----|----|---|---|---|---|---|---|---|---|---|---|---|-----|-----|-----|-----|-----|---|-----|---|-----|
| | (INFOT) | (OUTPUT) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | | | | | | | | | | | | | | | | |
| t _{PLH} | Α | В | 3.6 | 0.5 | 6.2 | 0.5 | 5.2 | 0.5 | 4.1 | 0.5 | 3.7 | 20 | | | | | | | | | | | | | | | | | | | | | | |
| t _{PHL} | А | A | A | В | 3.6 | 0.5 | 6.2 | 0.5 | 5.2 | 0.5 | 4.1 | 0.5 | 3.7 | ns | | | | | | | | | | | | | | | | | | | | |
| t _{PLH} | В | Α | 3.3 | 0.5 | 6.2 | 0.5 | 5.9 | 0.5 | 5.6 | 0.5 | 5.5 | 20 | | | | | | | | | | | | | | | | | | | | | | |
| t _{PHL} | В | A | 3.3 | 0.5 | 6.2 | 0.5 | 5.9 | 0.5 | 5.6 | 0.5 | 5.5 | ns | | | | | | | | | | | | | | | | | | | | | | |
| t _{PZH} | ŌĒ | ^ | 4.3 | 1 | 10.1 | 1 | 10.1 | 1 | 10.1 | 1 | 10.1 | 20 | | | | | | | | | | | | | | | | | | | | | | |
| t _{PZL} | OE | Α | 4.3 | 1 | 10.1 | 1 | 10.1 | 1 | 10.1 | 1 | 10.1 | ns | | | | | | | | | | | | | | | | | | | | | | |
| t _{PZH} | ŌĒ | В | 5.6 | 1 | 10.1 | 0.5 | 8.1 | 0.5 | 5.9 | 0.5 | 5.2 | 20 | | | | | | | | | | | | | | | | | | | | | | |
| t _{PZL} | OE | В | 5.6 | 1 | 10.1 | 0.5 | 8.1 | 0.5 | 5.9 | 0.5 | 5.2 | ns | | | | | | | | | | | | | | | | | | | | | | |
| t _{PHZ} | OF. | ^ | 4.5 | 1.5 | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | 20 | | | | | | | | | | | | | | | | | | | | | | |
| t _{PLZ} | OE | ŌĒ A | 4.5 | 1.5 | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | ns | | | | | | | | | | | | | | | | | | | | | | |
| t _{PHZ} | ŌĒ | D | 5.5 | 1.5 | 8.7 | 1.5 | 7.5 | 1 | 6.5 | 1 | 6.3 | 20 | | | | | | | | | | | | | | | | | | | | | | |
| t _{PLZ} | | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | В | В | В | В | В | В | В | В | В | В | В | В | В | В | 5.5 | 1.5 | 8.7 | 1.5 | 7.5 | 1 | 6.5 | 1 | 6.3 |

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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 11)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT | | | | | | | |
|------------------|-----------------|----------------|--------------------------|-----------------------------|-----|-----------------------------|-----|--------------------------|-----|--------------------------|-----|------|-----|-----|-----|-----|-----|-----|---|
| | (INPUT) | (OUTPUT) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | |
| t _{PLH} | А | В | 3.4 | 0.5 | 5.9 | 0.5 | 4.8 | 0.5 | 3.7 | 0.5 | 3.3 | ns | | | | | | | |
| t _{PHL} | A | А | А | ь | 3.4 | 0.5 | 5.9 | 0.5 | 4.8 | 0.5 | 3.7 | 0.5 | 3.3 | 115 | | | | | |
| t _{PLH} | В | Α | 3 | 0.5 | 5.2 | 0.5 | 4.8 | 0.5 | 4.5 | 0.5 | 4.4 | ns | | | | | | | |
| t _{PHL} | ь | A | 3 | 0.5 | 5.2 | 0.5 | 4.8 | 0.5 | 4.5 | 0.5 | 4.4 | 115 | | | | | | | |
| t _{PZH} | ŌĒ | Α | 3.4 | 1 | 7.8 | 1 | 7.8 | 1 | 7.8 | 1 | 7.8 | ns | | | | | | | |
| t _{PZL} | OE | A | 3.4 | 1 | 7.8 | 1 | 7.8 | 1 | 7.8 | 1 | 7.8 | 115 | | | | | | | |
| t _{PZH} | ŌĒ | В | 5.4 | 1 | 9.2 | 0.5 | 7.4 | 0.5 | 5.3 | 0.5 | 4.5 | ns | | | | | | | |
| t _{PZL} | OL | В | 5.4 | 1 | 9.2 | 0.5 | 7.4 | 0.5 | 5.3 | 0.5 | 4.5 | 115 | | | | | | | |
| t _{PHZ} | ŌĒ | Α | 4.2 | 1.5 | 7.7 | 1.5 | 7.7 | 1.5 | 7.7 | 1.5 | 7.7 | ns | | | | | | | |
| t _{PLZ} | OE | A | 4.2 | 1.5 | 7.7 | 1.5 | 7.7 | 1.5 | 7.7 | 1.5 | 7.7 | 115 | | | | | | | |
| t _{PHZ} | ŌĒ | ŌĒ | ŌĒ | ŌĒ | E B | 5.2 | 1.5 | 8.4 | 1.5 | 7.1 | 1 | 5.9 | 1 | 5.7 | ns | | | | |
| t _{PLZ} | | | | | ŌĒ | ŌĒ | OE | OE | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | 5.2 | 1.5 | 8.4 | 1.5 | 7.1 | 1 |

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (see Figure 11)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT | | | | | | | |
|------------------|-----------------|----------------|--------------------------|--------------------------|-----|--------------------------|-----|--------------------------|-----|--------------------------|-----|------|-----|---|-----|----|-----|---|-----|
| | (INPOT) | (001701) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | |
| t _{PLH} | А | В | 3.2 | 0.5 | 5.6 | 0.5 | 4.5 | 0.5 | 3.3 | 0.5 | 2.8 | 20 | | | | | | | |
| t _{PHL} | A | Ь | 3.2 | 0.5 | 5.6 | 0.5 | 4.5 | 0.5 | 3.3 | 0.5 | 2.8 | ns | | | | | | | |
| t _{PLH} | В | Α | 2.6 | 0.5 | 4.1 | 0.5 | 3.7 | 0.5 | 3.3 | 0.5 | 3.2 | ns | | | | | | | |
| t _{PHL} | Б | A | 2.6 | 0.5 | 4.1 | 0.5 | 3.7 | 0.5 | 3.3 | 0.5 | 3.2 | 115 | | | | | | | |
| t _{PZH} | OE | Α | 2.5 | 0.5 | 5.3 | 0.5 | 5.3 | 0.5 | 5.3 | 0.5 | 5.3 | 20 | | | | | | | |
| t _{PZL} | OE | A | 2.5 | 0.5 | 5.3 | 0.5 | 5.3 | 0.5 | 5.3 | 0.5 | 5.3 | ns | | | | | | | |
| t _{PZH} | ŌĒ | В | 5.2 | 0.5 | 9.4 | 0.5 | 7.3 | 0.5 | 5.1 | 0.5 | 4.5 | 20 | | | | | | | |
| t _{PZL} | OE | Ь | 5.2 | 0.5 | 9.4 | 0.5 | 7.3 | 0.5 | 5.1 | 0.5 | 4.5 | ns | | | | | | | |
| t _{PHZ} | ŌĒ | Α | 3 | 1 | 6.1 | 1 | 6.1 | 1 | 6.1 | 1 | 6.1 | 20 | | | | | | | |
| t_{PLZ} | OE | A | 3 | 1 | 6.1 | 1 | 6.1 | 1 | 6.1 | 1 | 6.1 | ns | | | | | | | |
| t _{PHZ} | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | 5 | 1 | 7.9 | 1 | 6.6 | 1 | 6.1 | 1 | 5.2 | 20 | | | |
| t _{PLZ} | | | | | | ŌĒ | OĒ | OE | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | 5 | 1 | 7.9 | 1 | 6.6 |



SCES551C-FEBRUARY 2004-REVISED AUGUST 2005

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (see Figure 11)

| PARAMETER | FROM (INPUT) | | - | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0 .1 | 1.5 V I V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT | | | |
|------------------|-----------------|----------|------|----------------|--------------------------|-------------------------------------|--------------|-----------------------------|------|-----------------------------|-----|-----------------------------|-----|------|-----|-----|-----|
| | (INPUT) | (001701) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | |
| t _{PLH} | ٨ | В | 3.2 | 0.5 | 5.5 | 0.5 | 4.4 | 0.5 | 3.2 | 0.5 | 2.7 | no | | | | | |
| t _{PHL} | A | Α | Α | A | A | | 3.2 | 0.5 | 5.5 | 0.5 | 4.4 | 0.5 | 3.2 | 0.5 | 2.7 | ns | |
| t _{PLH} | В | Α | 2.8 | 0.5 | 3.7 | 0.5 | 3.3 | 0.5 | 2.8 | 0.5 | 2.7 | ns | | | | | |
| t _{PHL} | Ь | A | 2.8 | 0.5 | 3.7 | 0.5 | 3.3 | 0.5 | 2.8 | 0.5 | 2.7 | 115 | | | | | |
| t _{PZH} | ŌĒ | Α | 2.2 | 0.5 | 4.3 | 0.5 | 4.2 | 0.5 | 4.1 | 0.5 | 4 | no | | | | | |
| t _{PZL} | OE | A | 2.2 | 0.5 | 4.3 | 0.5 | 4.2 | 0.5 | 4.1 | 0.5 | 4 | ns | | | | | |
| t _{PZH} | ŌĒ | В | 5.1 | 0.5 | 9.3 | 0.5 | 7.2 | 0.5 | 4.9 | 0.5 | 4 | ns | | | | | |
| t _{PZL} | OE | ь | 5.1 | 0.5 | 9.3 | 0.5 | 7.2 | 0.5 | 4.9 | 0.5 | 4 | 115 | | | | | |
| t _{PHZ} | ŌĒ | Α | 3.4 | 0.5 | 5 | 0.5 | 5 | 0.5 | 5 | 0.5 | 5 | ns | | | | | |
| t _{PLZ} | OE | A | 3.4 | 0.5 | 5 | 0.5 | 5 | 0.5 | 5 | 0.5 | 5 | 115 | | | | | |
| t _{PHZ} | ŌĒ | ŌĒ | OE B | 4.9 | 1 | 7.7 | 1 | 6.5 | 1 | 5.2 | 0.5 | 5 | no | | | | |
| t _{PLZ} | | | ŌĒ | ŌĒ | ŌĒ | ŌĒ | OE | ŌĒ | ŌĒ B | 4.9 | 1 | 7.7 | 1 | 6.5 | 1 | 5.2 | 0.5 |

Operating Characteristics

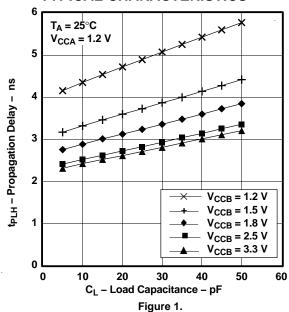
 $T_A = 25^{\circ}C$

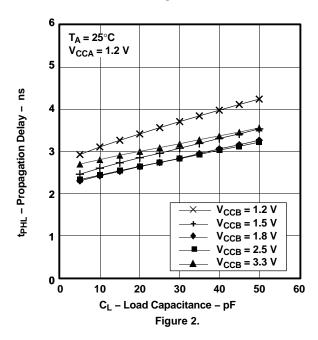
| PARAMETER | | | TEST CONDITIONS | V _{CCA} = V _{CCB} = 1.2 V | V _{CCA} = V _{CCB} = 1.5 V | V _{CCA} = V _{CCB} = 1.8 V | V _{CCA} = V _{CCB} = 2.5 V | V _{CCA} = V _{CCB} = 3.3 V | UNIT | |
|---------------------------------|--------|---------------------|---|---|---|---|---|---|------|--|
| | | | | TYP | TYP | TYP | TYP | TYP | | |
| | A to B | Outputs enabled | $C_{L} = 0,$ $f = 10 \text{ MHz},$ $t_{r} = t_{f} = 1 \text{ ns}$ | 1 | 1 | 1 | 1 | 2 | | |
| C _{pdA} ⁽¹⁾ | AIOB | Outputs disabled | | 1 | 1 | 1 | 1 | 1 | pF | |
| | B to A | Outputs enabled | | 13 | 13 | 14 | 15 | 16 | | |
| | | Outputs disabled | | 1 | 1 | 1 | 1 | 1 | | |
| | A to B | Outputs enabled | | 13 | 13 | 14 | 15 | 16 | | |
| C _{pdB} ⁽¹⁾ | AIOB | Outputs disabled | $C_L = 0,$ f = 10 MHz, | 1 | 1 | 1 | 1 | 1 | ~F | |
| | B to A | Outputs enabled | $t_r = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$ | 1 | 1 | 1 | 1 | 2 | pF | |
| | | Outputs disabled | | 1 | 1 | 1 | 1 | 1 | | |

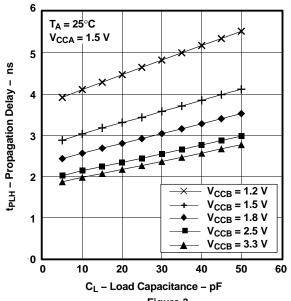
⁽¹⁾ Power dissipation capacitance per transceiver

Table 1. Typical Total Static Power Consumption ($I_{CCA} + I_{CCB}$)

| V | V _{CCA} | | | | | | | | | | |
|------------------|------------------|-------|-------|-------|-------|-------|------|--|--|--|--|
| V _{CCB} | 0 V | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 3.3 V | UNIT | | | | |
| 0 V | 0 | <0.5 | <0.5 | <0.5 | <0.5 | <0.5 | | | | | |
| 1.2 V | <0.5 | <1 | <1 | <1 | <1 | 1 | | | | | |
| 1.5 V | <0.5 | <1 | <1 | <1 | <1 | 1 | ^ | | | | |
| 1.8 V | <0.5 | <1 | <1 | <1 | <1 | <1 | μΑ | | | | |
| 2.5 V | <0.5 | 1 | <1 | <1 | <1 | <1 | | | | | |
| 3.3 V | <0.5 | 1 | <1 | <1 | <1 | <1 | | | | | |









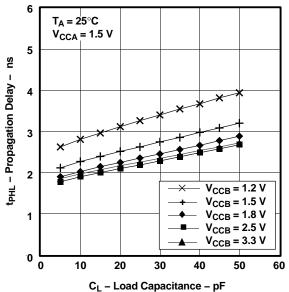
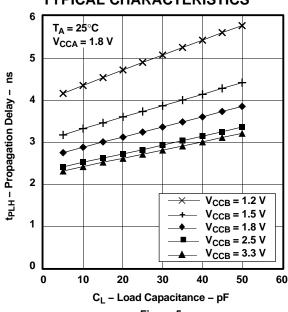
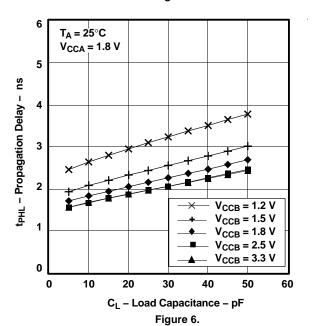


Figure 4.

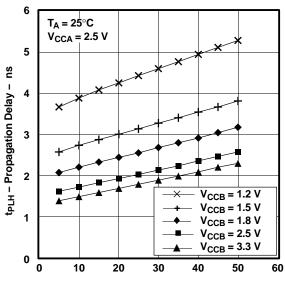




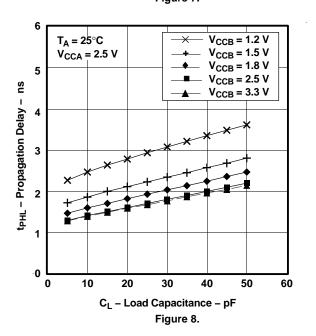




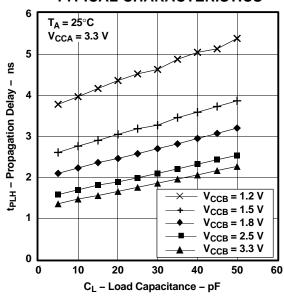




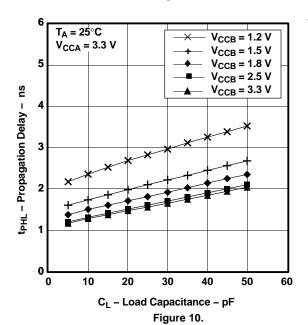
C_L – Load Capacitance – pF Figure 7.



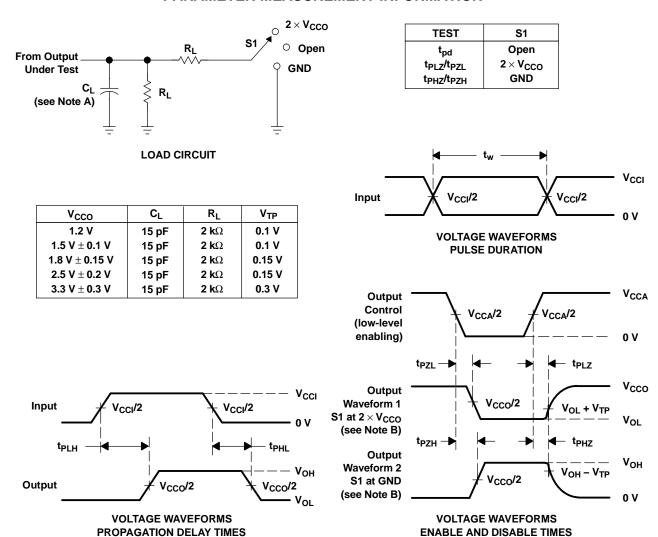








PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $dv/dt \geq 1 V/ns$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

Figure 11. Load Circuit and Voltage Waveforms





com 27-Sep-2007

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|----------------------------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| 74AVC16T245DGGRE4 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AVC16T245DGGRG4 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AVC16T245DGVRE4 | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AVC16T245DGVRG4 | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC16T245DGGR | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC16T245DGVR | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC16T245GQLR | NRND | BGA MI CROSTA R JUNI OR | GQL | 56 | 1000 | TBD | SNPB | Level-1-240C-UNLIM |
| SN74AVC16T245ZQLR | ACTIVE | BGA MI CROSTA R JUNI OR | ZQL | 56 | 1000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures. TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

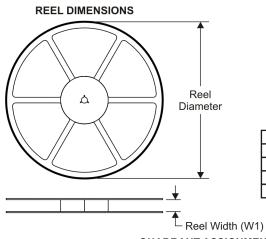
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19-Mar-2008

TAPE AND REEL INFORMATION



TAPE DIMENSIONS $\phi \phi \phi$ \oplus Cavity → A0 **←**

| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| D1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|----------------------------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74AVC16T245DGGR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 15.8 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74AVC16T245DGVR | TVSOP | DGV | 48 | 2000 | 330.0 | 24.4 | 6.8 | 10.1 | 1.6 | 12.0 | 24.0 | Q1 |
| SN74AVC16T245GQLR | BGA MI CROSTA R JUNI OR | GQL | 56 | 1000 | 330.0 | 16.4 | 4.8 | 7.3 | 1.5 | 8.0 | 16.0 | Q1 |
| SN74AVC16T245GQLR | BGA MI CROSTA R JUNI OR | GQL | 56 | 1000 | 330.0 | 16.4 | 4.8 | 7.3 | 1.45 | 8.0 | 16.0 | Q1 |
| SN74AVC16T245ZQLR | BGA MI CROSTA R JUNI OR | ZQL | 56 | 1000 | 330.0 | 16.4 | 4.8 | 7.3 | 1.45 | 8.0 | 16.0 | Q1 |
| SN74AVC16T245ZQLR | BGA MI CROSTA R JUNI OR | ZQL | 56 | 1000 | 330.0 | 16.4 | 4.8 | 7.3 | 1.5 | 8.0 | 16.0 | Q1 |





*All dimensions are nomina

| All dimensions are nominal | | | | | | | |
|----------------------------|-------------------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| SN74AVC16T245DGGR | TSSOP | DGG | 48 | 2000 | 346.0 | 346.0 | 41.0 |
| SN74AVC16T245DGVR | TVSOP | DGV | 48 | 2000 | 346.0 | 346.0 | 41.0 |
| SN74AVC16T245GQLR | BGA MICROSTAR JUNIOR | GQL | 56 | 1000 | 333.2 | 345.9 | 28.6 |
| SN74AVC16T245GQLR | BGA MICROSTAR JUNIOR | GQL | 56 | 1000 | 346.0 | 346.0 | 33.0 |
| SN74AVC16T245ZQLR | BGA MICROSTAR JUNIOR | ZQL | 56 | 1000 | 346.0 | 346.0 | 33.0 |
| SN74AVC16T245ZQLR | BGA MICROSTAR JUNIOR | ZQL | 56 | 1000 | 333.2 | 345.9 | 28.6 |

GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



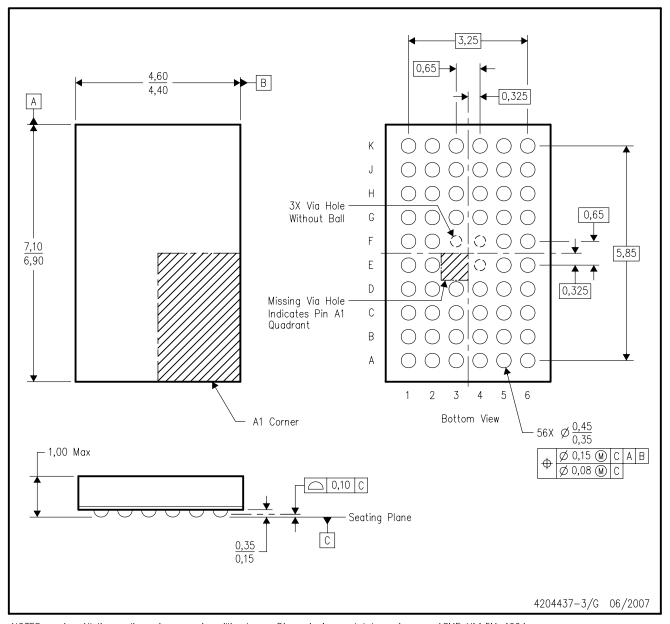
NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).



DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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| Security | www.ti.com/security |
| Telephony | www.ti.com/telephony |
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